



NOTE

1. SMT LEAD-COPLANARITY: 0.1 MAX.
2. THIS PRODUCT HAS NO POLARITY TO PATTERN FOR MOUNTING.
3. MAKE SURE WIDTH OF PATTERN IS WITHIN THAT OF LAND, OR LEAD MAY TOUCH PATTERN. (THIS APPLIES TO HATCHED AREA.)
4. STACKING HEIGHT FROM LEAD TO LEAD.
5. BOARD DISTANCE

2	COPPER ARROY	CONTACT : GOLD PLATING 0.76μm MIN LEAD : GOLD PLATING 0.03μm MIN UNDER : NICKEL PLATING 1.3μm MIN	3	COPPER ARROY	LEAD : GOLD PLATING 0.03μm MIN UNDER : NICKEL PLATING 1.3μm MIN			
1	LCP	BEIGE, UL94V-0						
NO.	MATERIAL	FINISH . REMARKS	NO.	MATERIAL	FINISH . REMARKS			
UNITS		SCALE	COUNT	DESCRIPTION OF REVISIONS		DESIGNED	CHECKED	DATE
mm		4:1						
HRS HIROSE ELECTRIC CO., LTD.		APPROVED : NH. NAKATA	16.11.10	DRAWING NO.		EDC-151975-93-00		
		CHECKED : HT. YAMAGUCHI	16.11.10	PART NO.		FX10B-168P-SV1(93)		
		DESIGNED : MT. ITANO	16.11.10	CODE NO.		CL570-0154-6-93		
		DRAWN : MT. ITANO	16.11.10					